

**Solid State Devices, Inc.**

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SPB-010

SPB-015

Designer's Data Sheet**Part Number/Ordering Information ^{1/}****SPB-0xx__****L Screening ^{2/}**

__ = Not Screened

TX = TX Level

TXV = TXV Level

S = S Level

Voltage

010 = 100 V

015 = 150 V

10 AMP

BYPASS DIODE ASSEMBLY

100 - 150 VOLTS

FEATURES:

- Designed for Space Use on Flexible Solar Panels
- Hermetically Sealed
- Wide Temperature Range: -100 to 150°C
- Qualified Design to 20,000 Temperature Cycles
- Flexible Leads – Welded or Soldered Termination
- Large Radiation Surface for Operation without Heatsink
- TX, TXV, or Space Level Screening Available^{2/}

Maximum Ratings		Symbol	Value	Unit
Peak Repetitive Reverse and DC Blocking Voltage ^{3/}	SPB-010 SPB-015	V_{RRM} V_{RWM} V_R	100 150	V
Average Rectified Forward Current (Resistive Load, 60 Hz Sine Wave, $T_C = 150^\circ\text{C}$)		I_O	10	A
Peak Surge Current (8.3 ms Pulse, Half Sine Wave, allow junction to reach equilibrium between pulses, $T_A = 25^\circ\text{C}$)		I_{FSM}	150	A
Operating & Storage Temperature		$T_{OP} \text{ \& } T_{STG}$	-100 to +150	°C
Maximum Thermal Resistance Junction to Case		$R_{\theta JC}$	0.8	°C/W

NOTES:

^{1/} For ordering information, operating curves, price, and availability, contact factory.

^{2/} Screening based on MIL-PRF-19500. Screening flows available on request.

BDA

*Dime used for size reference

NOTE: All specifications are subject to change without notification. SCD's for these devices should be reviewed by SSDI prior to release.

DATA SHEET #: RC0208A**DOCX**



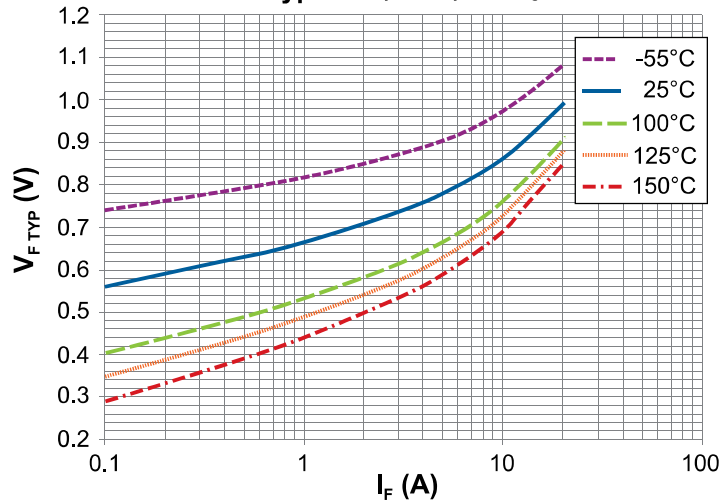
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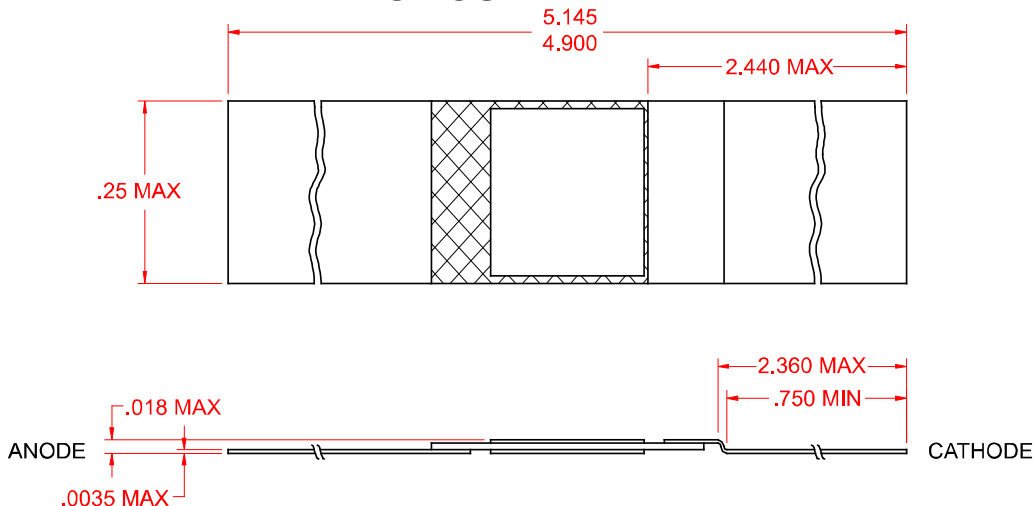
SPB-010 SPB-015

Electrical Characteristic		Symbol	Min	Max	Unit
Reverse Blocking Voltage ($I_R = 5 \text{ mA}_{DC}$, 300 μsec min pulse, $T_A = 25^\circ\text{C}$)	SPB-010 SPB-015	BV_R	100 150	-- --	V
Instantaneous Forward Voltage Drop ($I_F = 6 \text{ A}_{DC}$, 300 – 500 μsec pulse)	$T_A = 150^\circ\text{C}$ $T_A = 25^\circ\text{C}$ $T_A = -55^\circ\text{C}$	V_{F1} V_{F2} V_{F3}	-- -- --	0.78 0.90 1.05	V
Instantaneous Forward Voltage Drop ($I_F = 10 \text{ A}_{DC}$, 300 – 500 μsec pulse)	$T_A = 25^\circ\text{C}$	V_{F4}	--	0.95	V
Reverse Leakage Current ($V_R = V_{RRM}$, 300 μs min pulse)	$T_A = 25^\circ\text{C}$	I_{R1}	--	50	μA
Reverse Leakage Current ($V_R = 75\%$ of V_{RRM} , 300 μs min pulse)	$T_A = 100^\circ\text{C}$	I_{R2}	--	3.0	mA

SPB-0xx
Typical V_F vs I_F vs T_J



CASE OUTLINE: BDA



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